

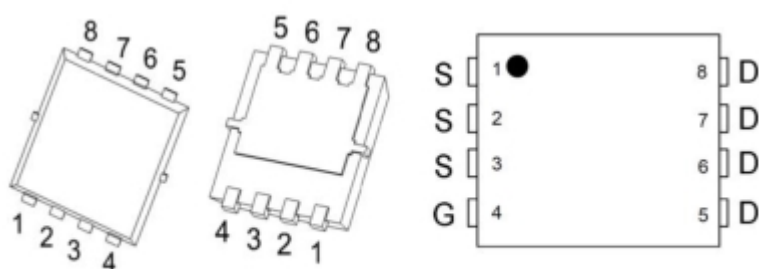
Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
30V	7.5m Ω @10V	20A
	9m Ω @4.5V	

Feature

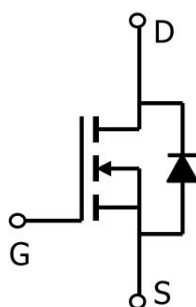
- Enhancement mode
- Low on-resistance $R_{DS(on)}$
- Pb-free lead plating; RoHS compliant

Package

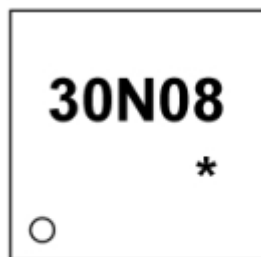


PDFNWB3.3×3.3-8L

Circuit diagram



Marking



30N08 =Device Code
***** =Month Code

Absolute maximum ratings

(T_a=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D	20	A
Pulsed Drain Current	I _{DM}	80	A
Single Pulse Avalanche Energy ¹	E _{AS}	112	mJ
Avalanche Current	I _{AS}	22	
Total Power Dissipation	P _D	21	W
Thermal Resistance from Junction to Ambient	R _{θJA}	7.1	°C/W
Storage Temperature Range	T _{STG}	-55 to 150	°C
Operating Junction Temperature Range	T _J	-55 to 150	°C

Electrical characteristics

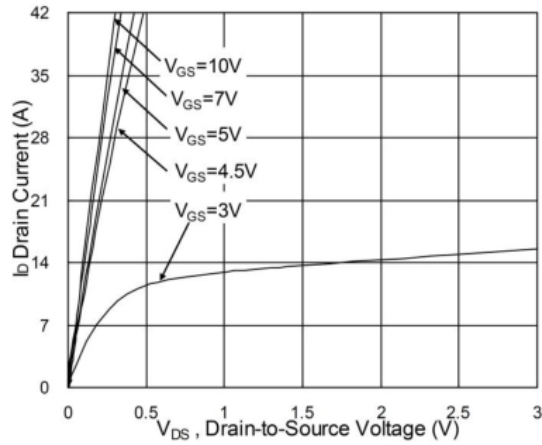
($T_A=25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV (BR)DSS	V _{GS} = 0V, I _D =250μA	30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} = 0V			1	uA
Gate-Source Leakage	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	uA
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1	1.5	2.2	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =8A		7.5	9	mΩ
		V _{GS} =4.5V, I _D =6A		9	14	
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =15V, V _{GS} =0V, f=1.0MHz		1317		pF
Output Capacitance	C _{Oss}			163		
Reverse Transfer Capacitance	C _{rss}			131		
Switching Characteristics						
Turn-on Delay Time	T _{d(on)}	V _{GS} =10V, V _{DS} =15V, I _D =10A, R _G =3Ω		6.2		nS
Turn-on Rise Time	T _r			59		
Turn-off Delay Time	T _{d(off)}			27.6		
Turn-off Fall Time	T _f			8.4		
Total Gate Charge	Q _g	V _{GS} =10V, V _{DS} =25V, I _D =12A		12.6		pF
Gate-Source Charge	Q _{gs}			4.2		
Gate-Drain Charge	Q _{gd}			5.1		
Source-Drain Diode Characteristics						
Gate-Drain Charge	V _{SD}	I _S =1A, V _{GS} = 0V			1.2	V

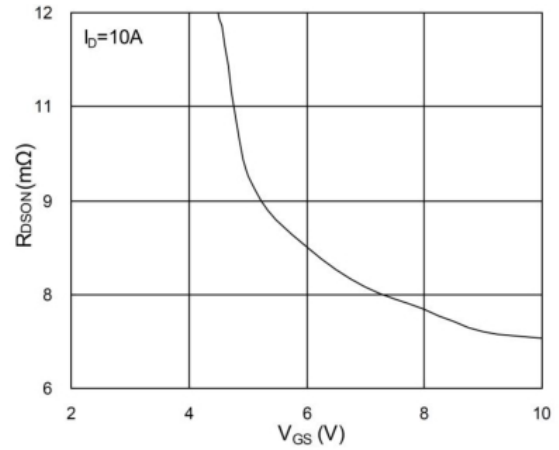
Notes:

1. $T_j=25^{\circ}\text{C}$, $V_{DD}=20V$, $V_G=10V$, $L=0.5mH$, $R_g=25\Omega$

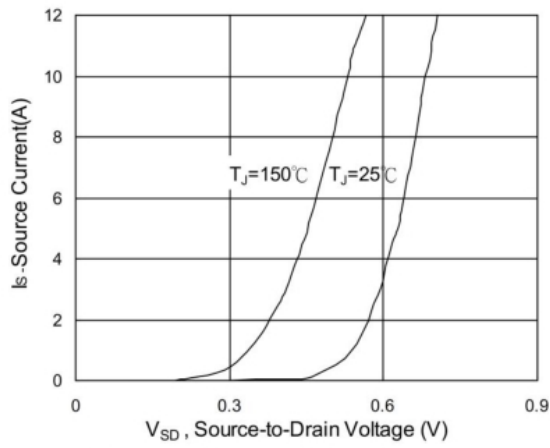
Typical Characteristics



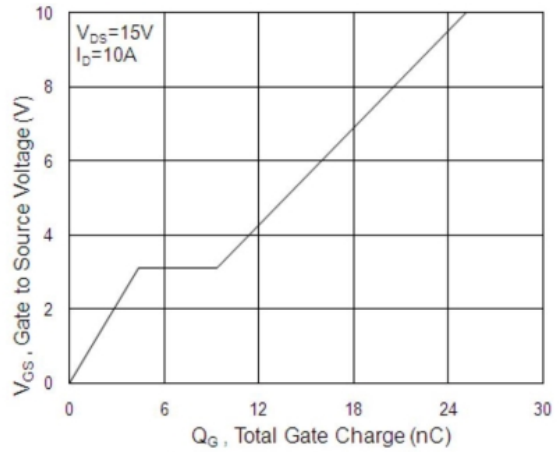
Typical Output Characteristics



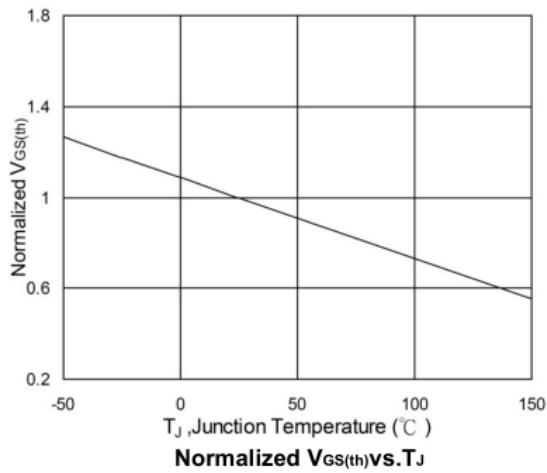
On-Resistance vs. Gate-Source



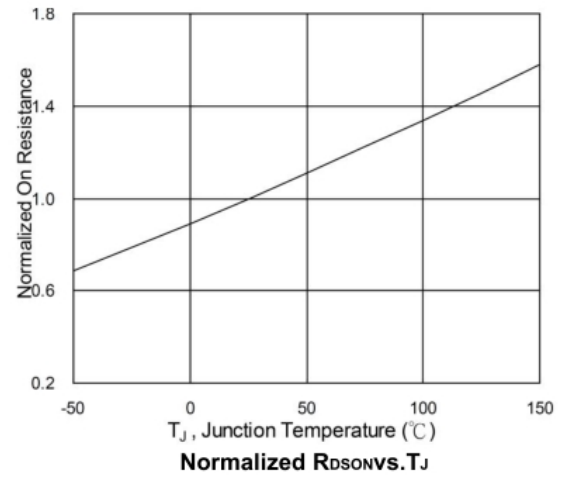
Forward Characteristics of reverse



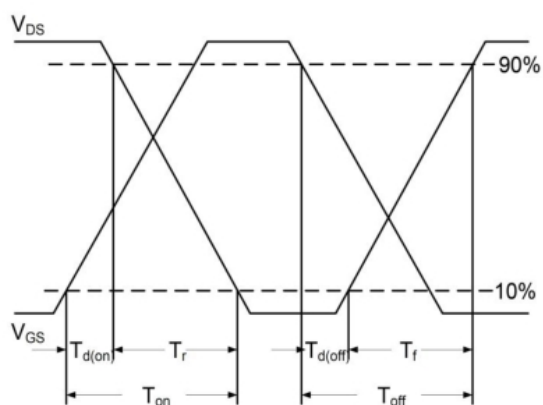
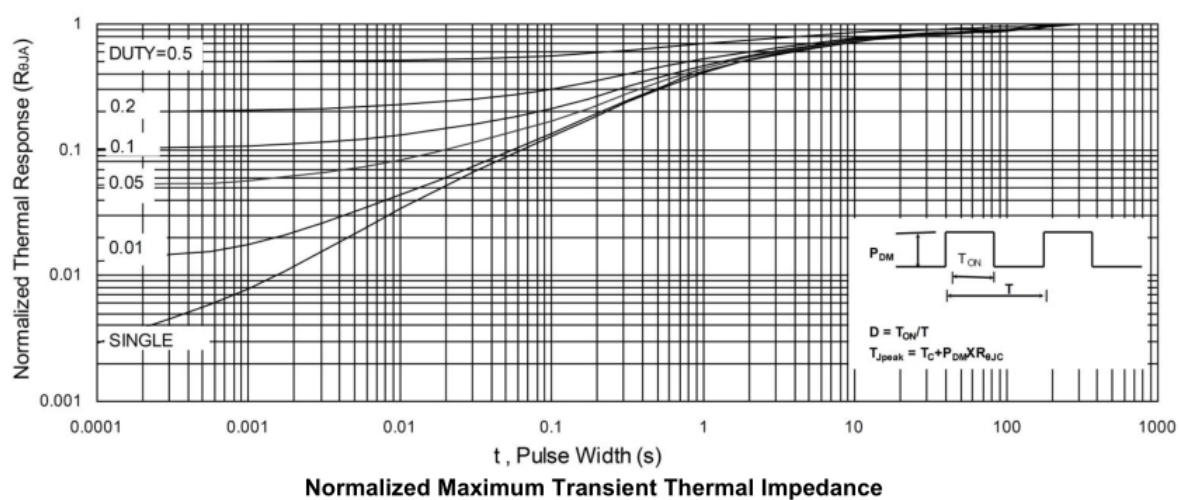
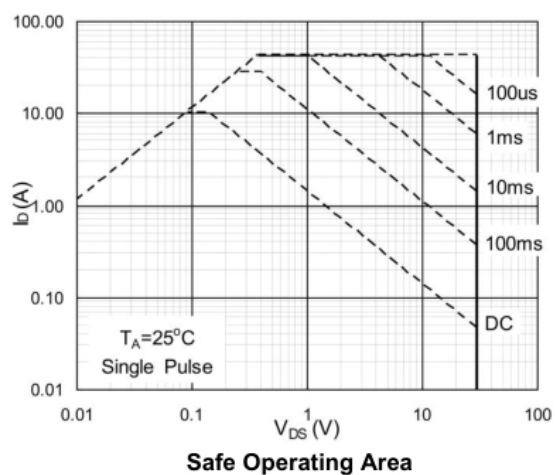
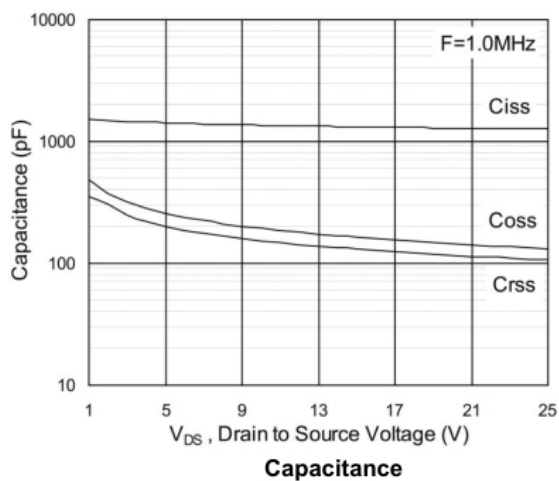
Gate-Charge Characteristics



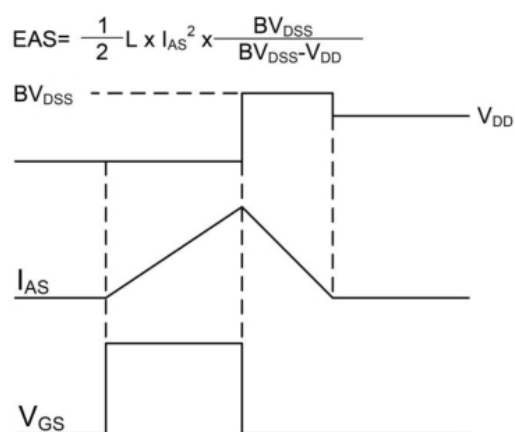
Normalized $V_{GS(th)}$ vs. T_J



Normalized $R_{DS(on)}$ vs. T_J

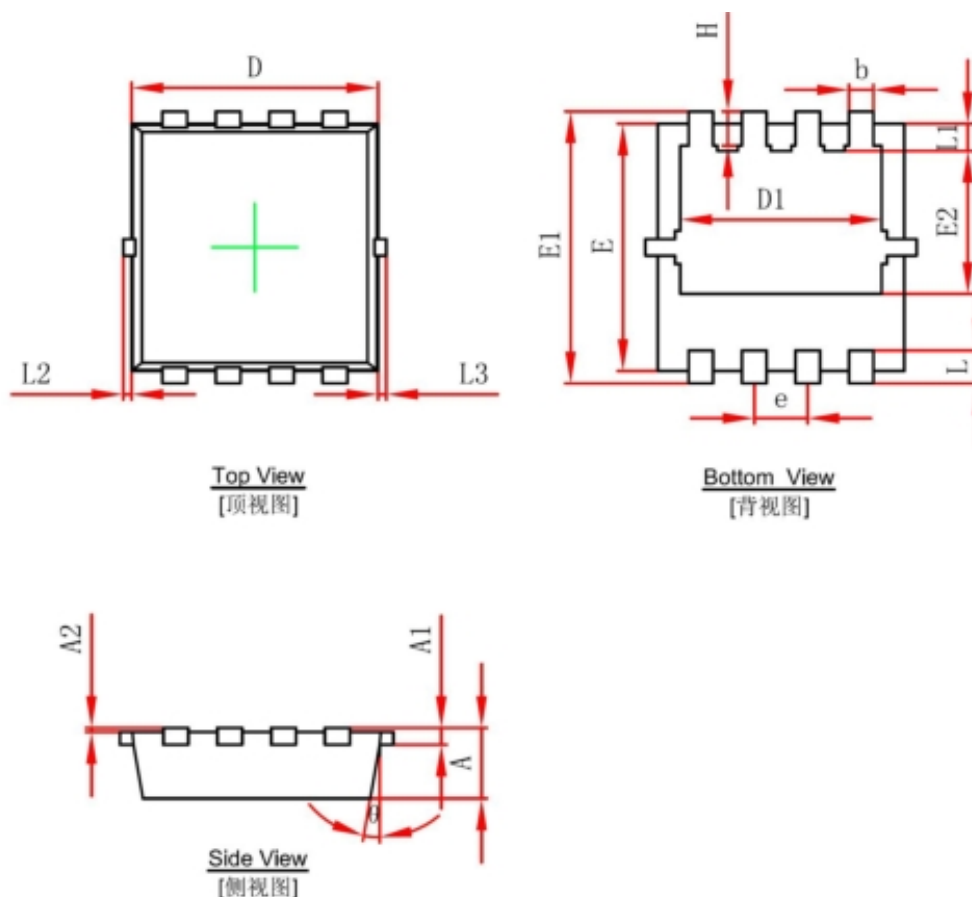


Switching Time Waveform



Unclamped Inductive Switching Waveform

PDFNWB3.3×3.3-8L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.650	0.850	0.026	0.033
A1	0.152 REF.		0.006 REF.	
A2	0~0.05		0~0.002	
D	2.900	3.100	0.114	0.122
D1	2.300	2.600	0.091	0.102
E	2.900	3.100	0.114	0.122
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0~0.100		0~0.004	
L3	0~0.100		0~0.004	
H	0.315	0.515	0.012	0.020
θ	9°	13°	9°	13°